5th Sustainable Technologies Conference

Zurich, 05 June 2012

Joachim Binder
Senior Director, Investor Relations

Table of Contents

- Infineon at a Glance; Q2 FY12 Results
- Infineon's Contribution to Energy Efficiency
- Outlook on Growth and Margins; Summary

Disclaimer:

This presentation contains forward-looking statements about the business, financial condition and earnings performance of the Infineon Group.

These statements are based on assumptions and projections resting upon currently available information and present estimates. They are subject to a multitude of uncertainties and risks. Actual business development may therefore differ materially from what has been expected.

Beyond disclosure requirements stipulated by law, Infineon does not undertake any obligation to update forward-looking statements.

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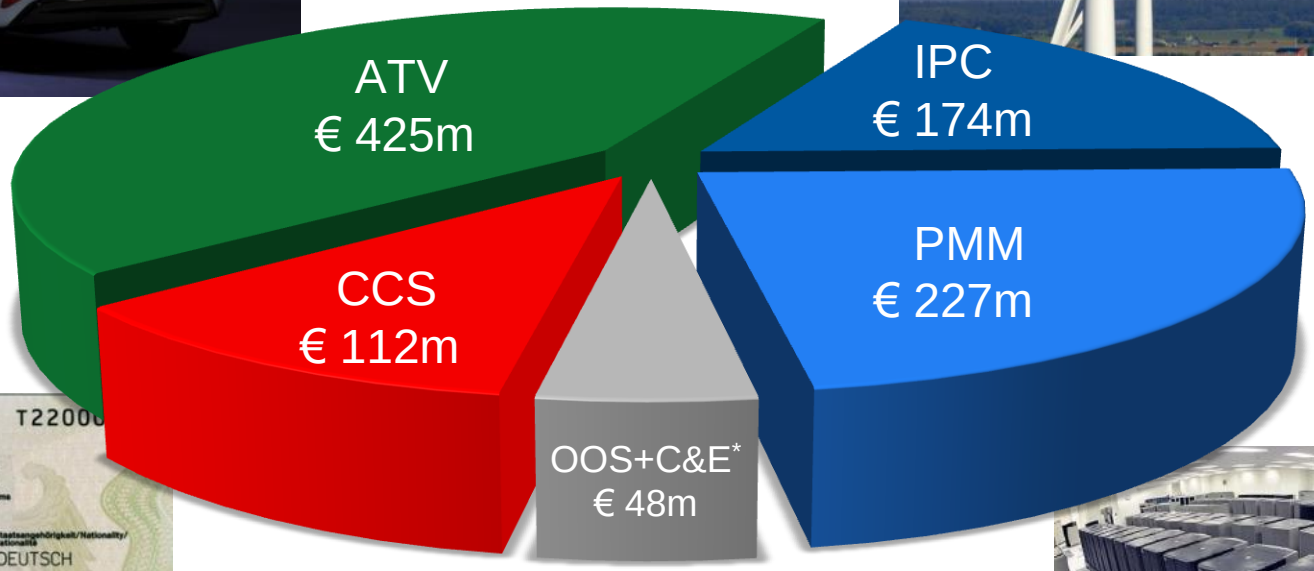
Revenue Split by Division

Q2 FY 2012 revenue: EUR 986m











* Other Operating Segments; Corporate & Eliminations.

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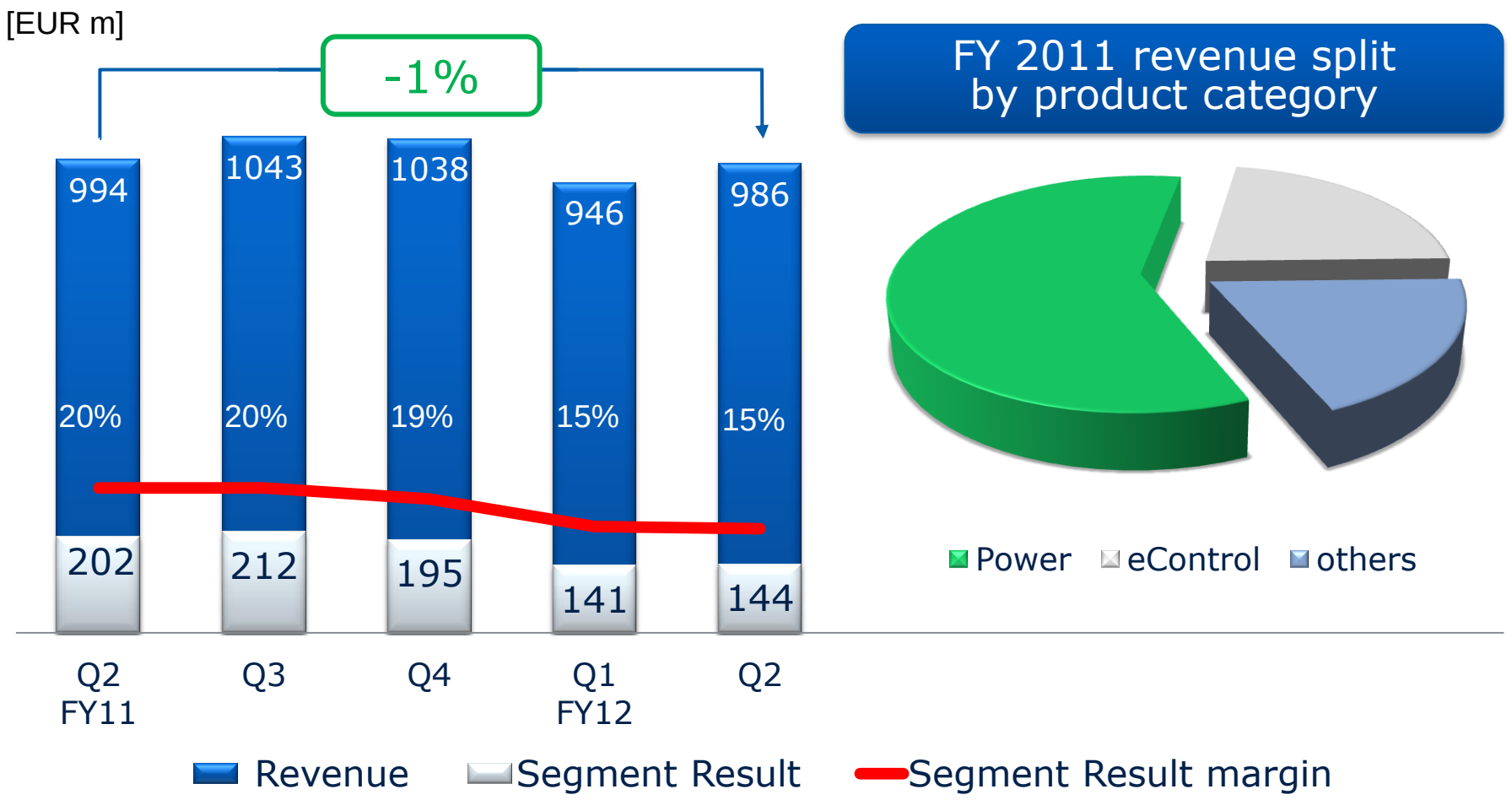
Q2 FY12: Maintained Solid Segment Result Margin

Revenue and Segment Result



FY 2011 revenue split by product category

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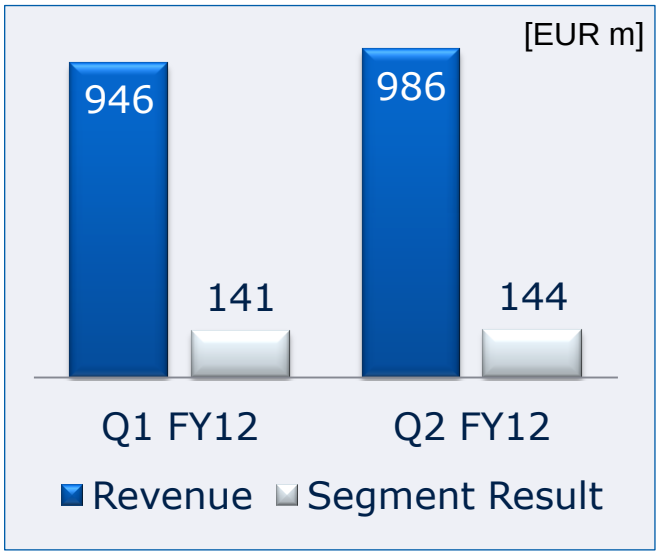
+4% Revenue Growth; Stable Segment Result Margin





[EUR m]	Q2 FY11	Q1 FY12	Q2 FY12
Revenue	994	946	986
Segment Result	202	141	144
SR Margin	20.3%	14.9%	14.6%
Net Income*	572	96	111
Investment	164	294	192
FCF from cont. operations	13	-234	-10
Gross Cash	2,691	2,337	2,190
Net Cash	2,335	2,068	1,927

- Net Income includes „income from discontinued operations, net of income taxes“ in Q2 FY11 EUR 399m, in Q1 FY12 EUR -8m and in Q2 FY12 EUR 2m.

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Tight Customer Relationships are Based on System Knowhow and App Understanding

ATV

Autoliv
HELLA
BOSCH
Continental
DELPHI
DENSO
LEAR CORPORATION
HYUNDAI
TRW
Valeo

IPC

ABB
ALSTOM
BOMBARDIER
ENERCON ENERGY FOR THE WORLD
Rockwell Automation
Schneider Electric
SIEMENS
SMA
SEMIKRON innovation+service

PMM

DELL
DELTA
EMERSON
ERICSSON TAKING YOU FORWARD
hp invent
LG Life's Good
Microsoft
power-one Changing the Shape of Power
SAMSUNG

CCS

gemalto security to be free
hp invent
Oberthur Card Systems
SAFRAN Morpho
Watchdata

Distributors

ARROW
AVNET
北京晶川电子技术发展有限责任公司 Beijing Jingchuan Electronic Technology Development Co.,Ltd
RUTRONIK EUROPE

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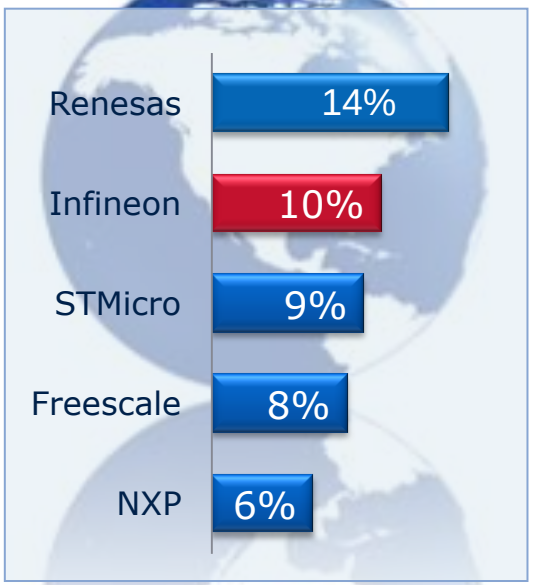
Infineon Holds Top Positions in All Target Markets

Automotive

#2

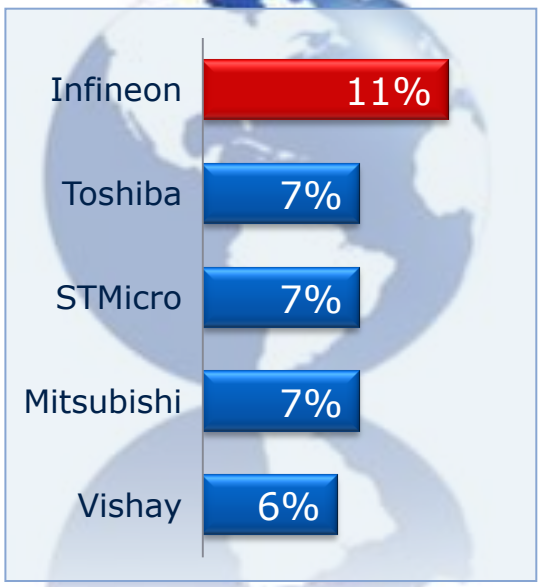


Calendar Year 2011.

Source: Strategy Analytics, April 2012.

Power

#1

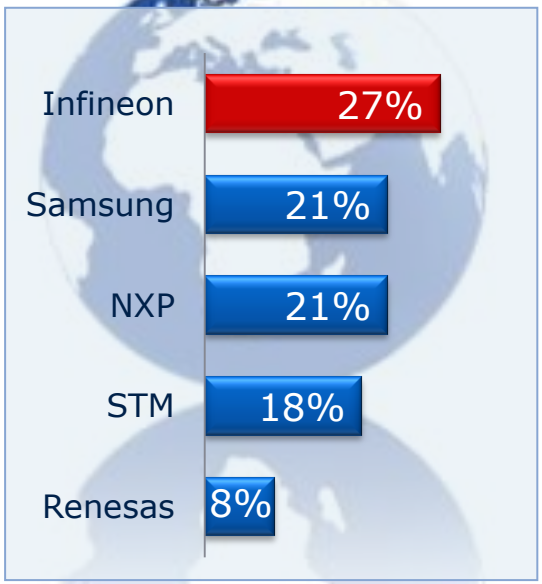


Calendar Year 2010.

Source: IMS Research, August 2011.

Chip Card

#1



Calendar Year 2010.

Source: IMS Research, August 2011.

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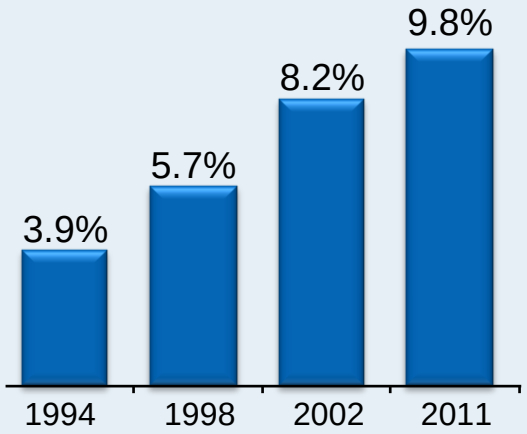
Automotive: Infineon Biggest Market Share Gainer Amongst All Players in 2011

Worldwide Automotive Semiconductor Ranking for 2011

1.	Renesas	13.8%	-0.3%-pt
2.	**Infineon**	**9.8%**	**+1.0%-pt**
3.	STM	8.7%	+0.4%-pt
4.	Freescale	7.9%	-0.5%-pt
5.	NXP	6.4%	-0.4%-pt
6.	Bosch	5.8%	+0.2%-pt



Infineon
- strengthened **world's #2** postion;
- rose from #8 to #4 position in Japan.

Europe

1.	**Infineon**	**14.7%**
2.	STM	11.3%
3.	Bosch	9.4%
4.	Freescale	8.7%
5.	NXP	8.2%
6.	Renesas	8.0%
7.	TI	6.8%
8.	ON Semi	3.0%

APAC & others*

1.	STM	10.1%
2.	**Infineon**	**9.0%**
3.	Renesas	7.5%
4.	Freescale	7.4%
5.	NXP	7.3%
6.	Bosch	5.7%
7.	Toshiba	2.9%
8.	TI	2.6%

North America

1.	Freescale	13.8%
2.	**Infineon**	**8.5%**
3.	STM	8.0%
4.	Renesas	7.5%
5.	NXP	6.7%
6.	TI	6.0%
7.	Bosch	3.7%
8.	ON	3.3%

Japan

1.	Renesas	35.1%
2.	Toshiba	13.0%
3.	Fujitsu	3.9%
4.	**Infineon**	**3.8%**
5.	Rohm	3.6%
6.	STM	3.6%
7.	ON	3.1%
8.	Sanken	2.9%

Source: Strategy Analytics, April 2012 * According to Strategy Analytics this ranking also includes Russia, South America, Australia and further countries.

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New Era: Multiple Factors Driving Demand for Power Semiconductors

'90 – '10	'10 – '30	Changes
	 Courtesy: Tesla	■ Electrification of powertrain fuels demand for high-power semis in cars and doubles silicon content.
		■ Shift towards renewable energies requires orders of magnitude more high-power semis per MW of power generated.
		■ Higher efficiency in power conversion lowers CO_2, material and electricity costs.
		■ Stronger demand for goods containing power semis due to faster increase in standard of living in BRIC countries.

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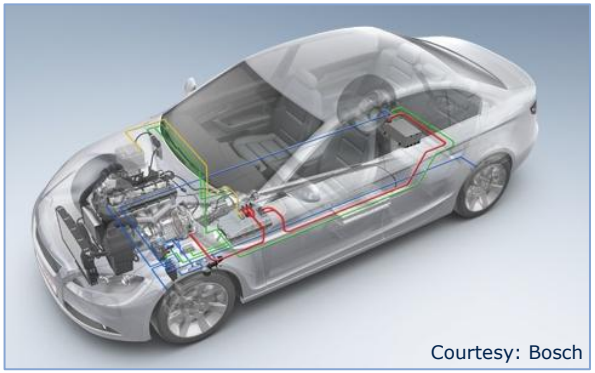
ICEs Still Bread-and-Butter Business; New Opportunities by HEV/EV

Classical car market		Electromobility
Vehicle production	**Semi content**	**HEV / EV**
	 Courtesy: Bosch	 Courtesy: Tesla
TAM: ~5% p.a.	TAM: 3-4% p.a.	TAM: > 25% p.a.
		small units but high growth
TAM: 8-9% p.a.		2%-pt p.a.

ATV: ~10% p.a.

Sources: CSM, Strategy Analytics (May 2012)

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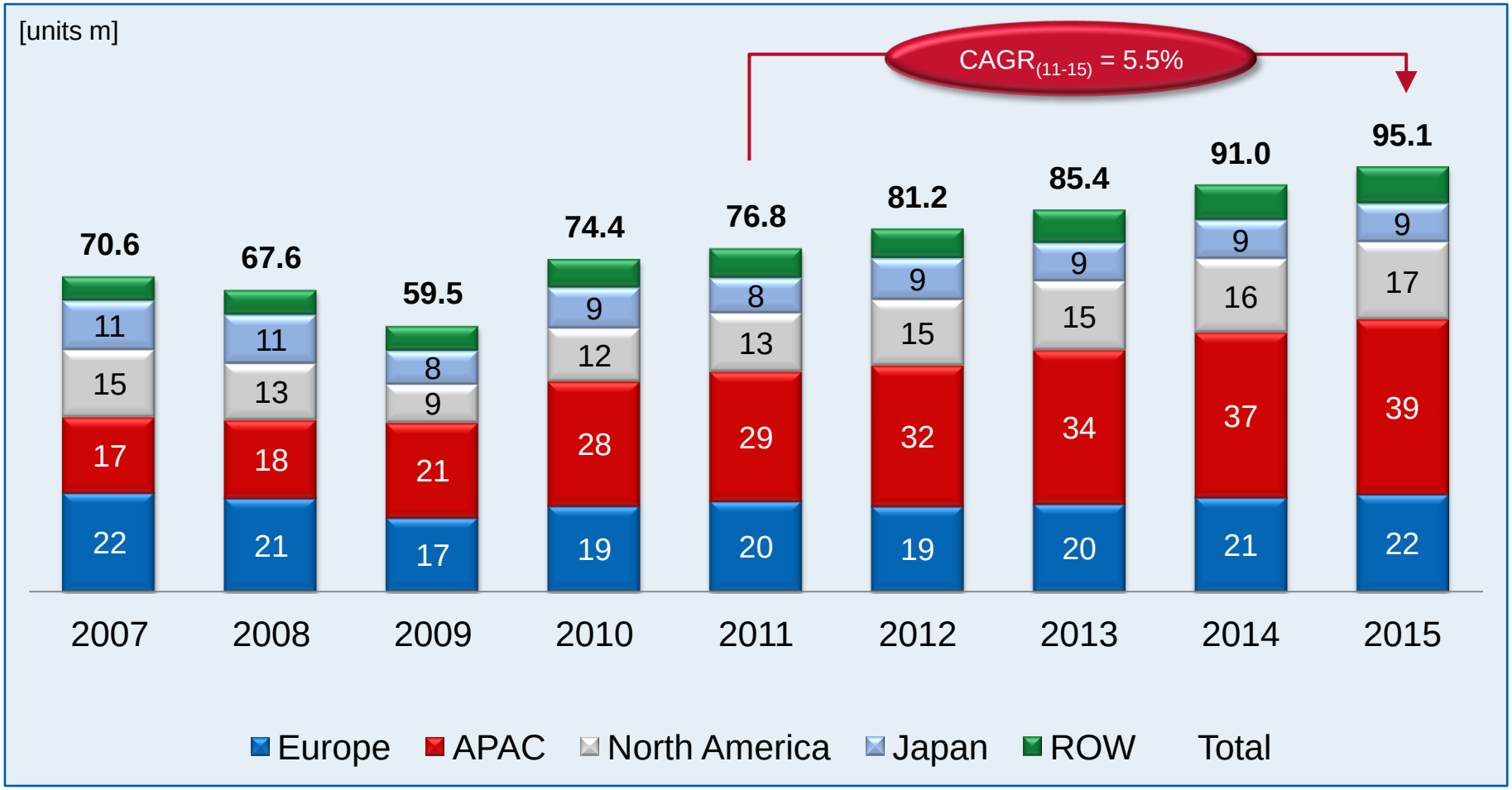
Healthy Growth in Global Car Production Expected

Global car production (cars ≤ 6t)



Source: IHS, April 2012.

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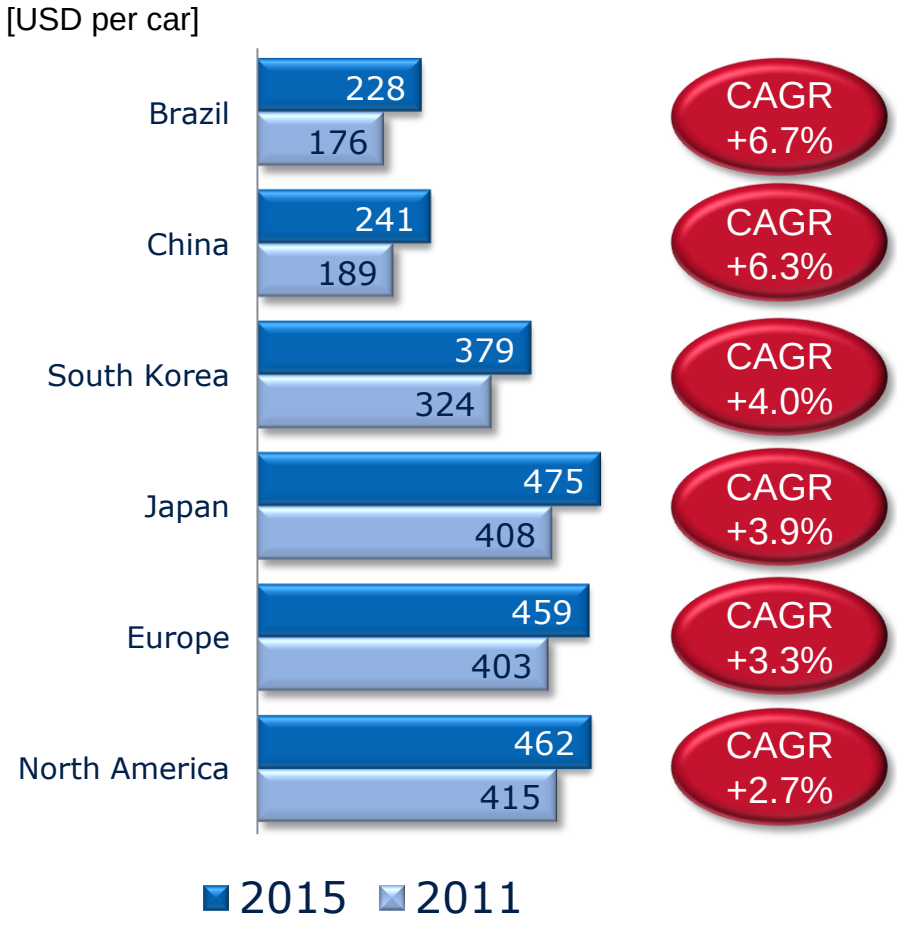
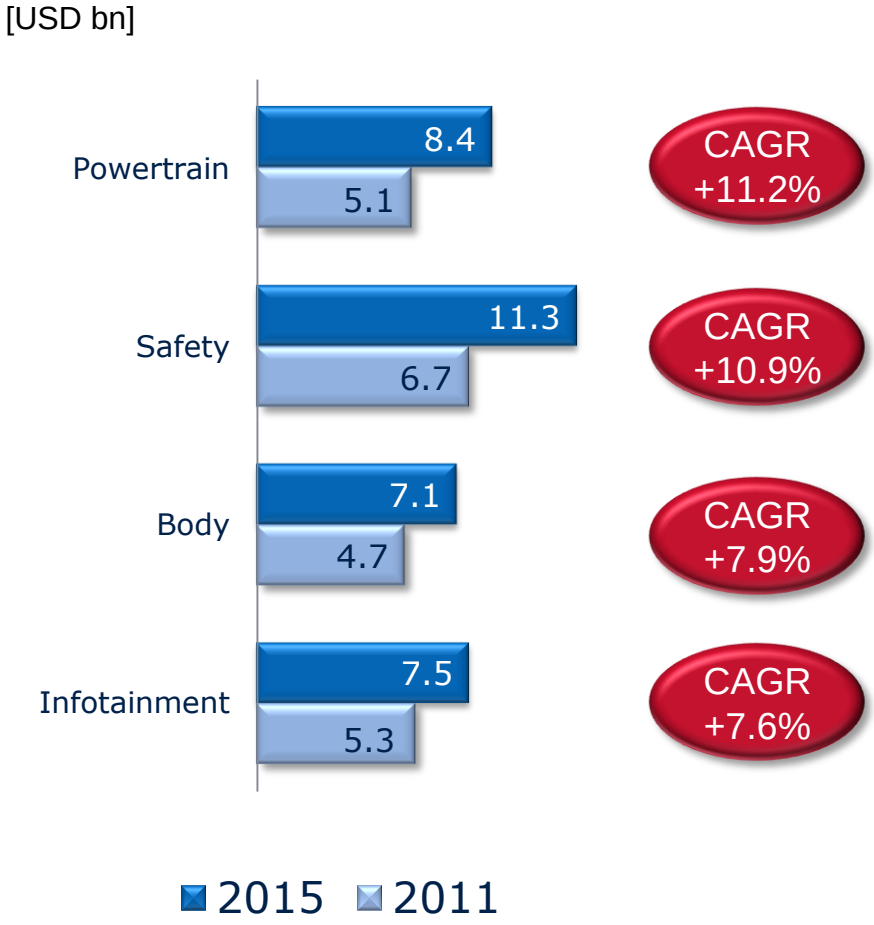
Rising Semiconductor Value Per Car Drives Market

Semiconductor value per car



Source: Strategy Analytics, Oct. 2011; including semiconductor sensors.

Semiconductor market by segment



Source: Strategy Analytics, January 2012.

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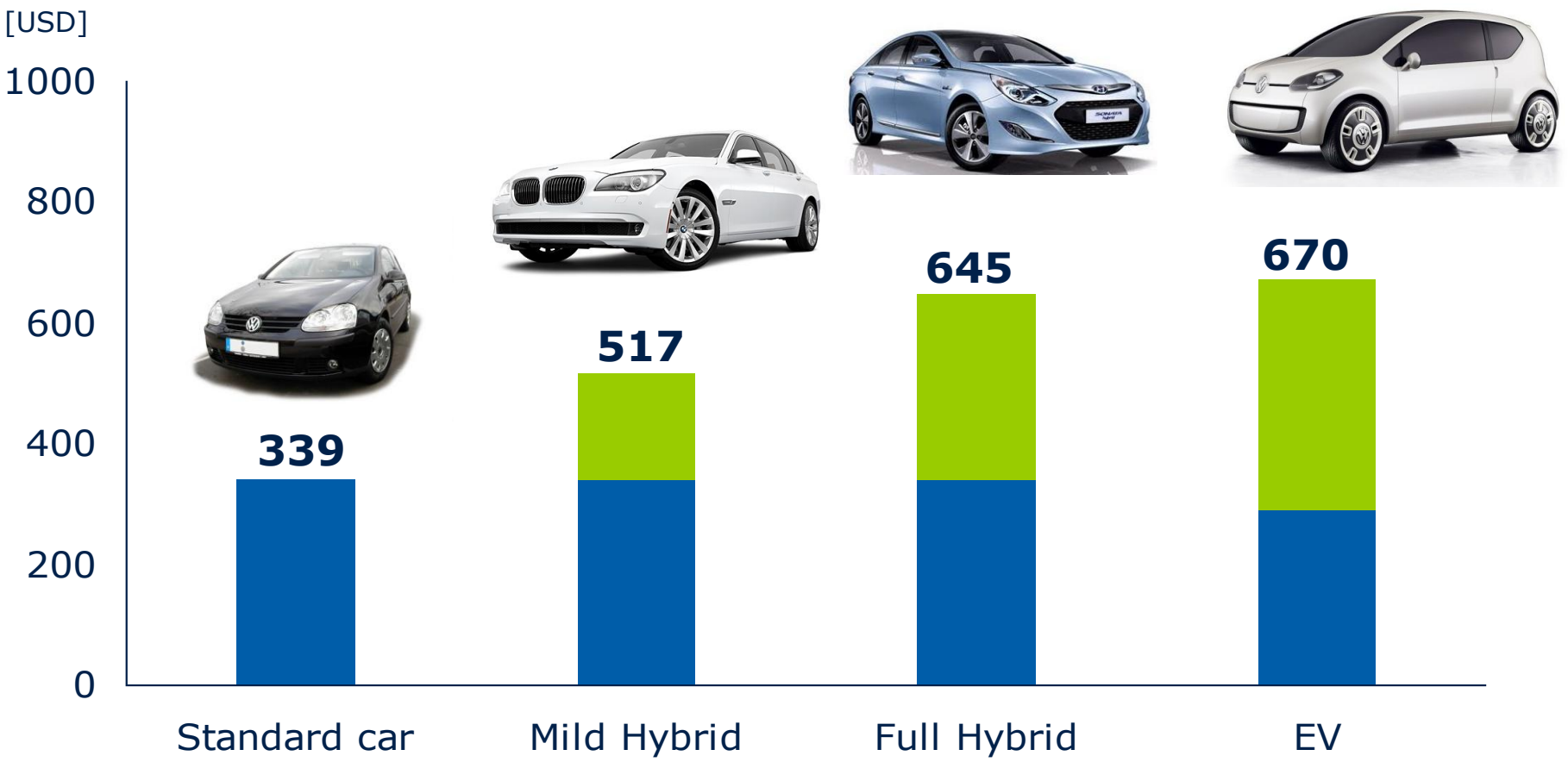
Electrification Doubles Semiconductor Content per Car

Semiconductor content per car in 2015



Source: Strategy Analytics, August/October 2011.

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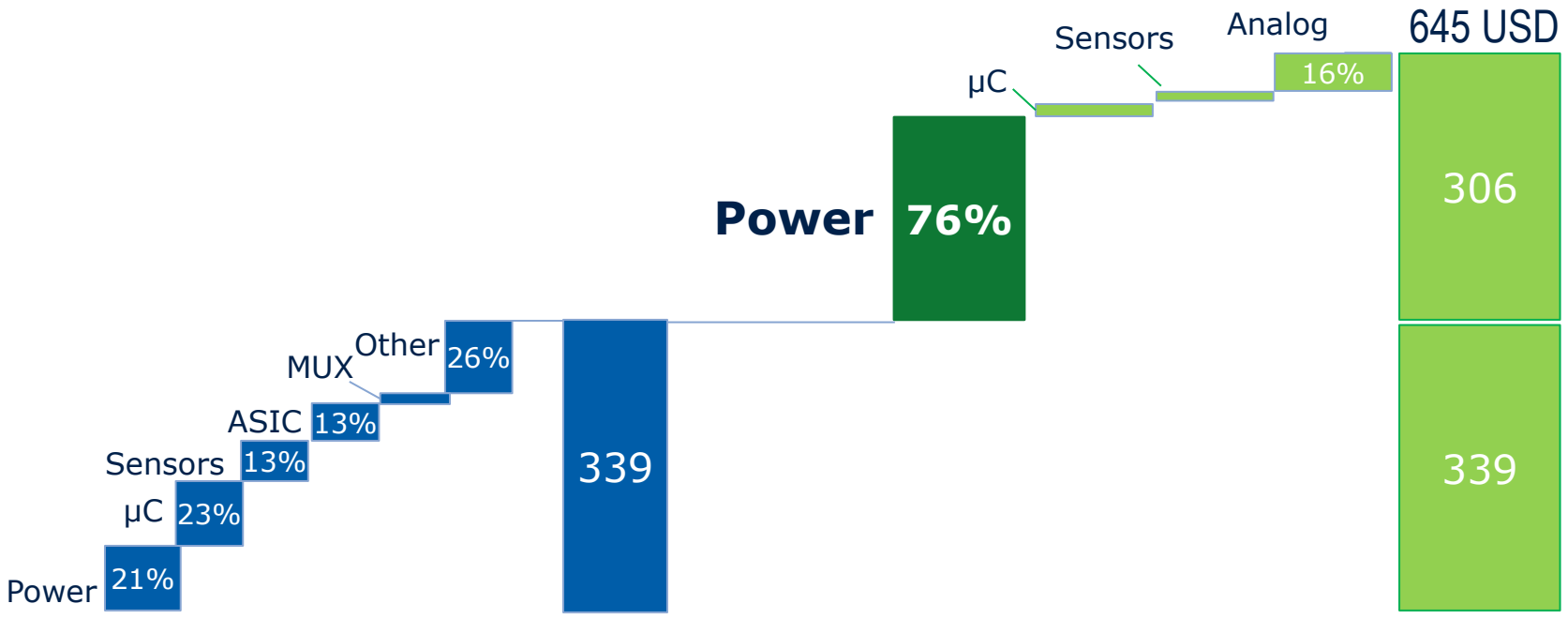
Three Quarters of Incremental Semi Content in Hybrid Vehicles is Power

Semiconductor bill-of-material for ICE and hybrid vehicles in 2015



Source: Strategy Analytics, October 2011.

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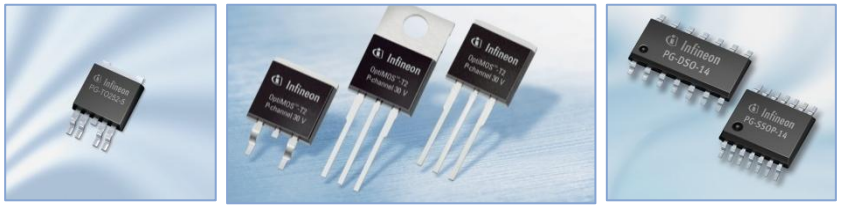
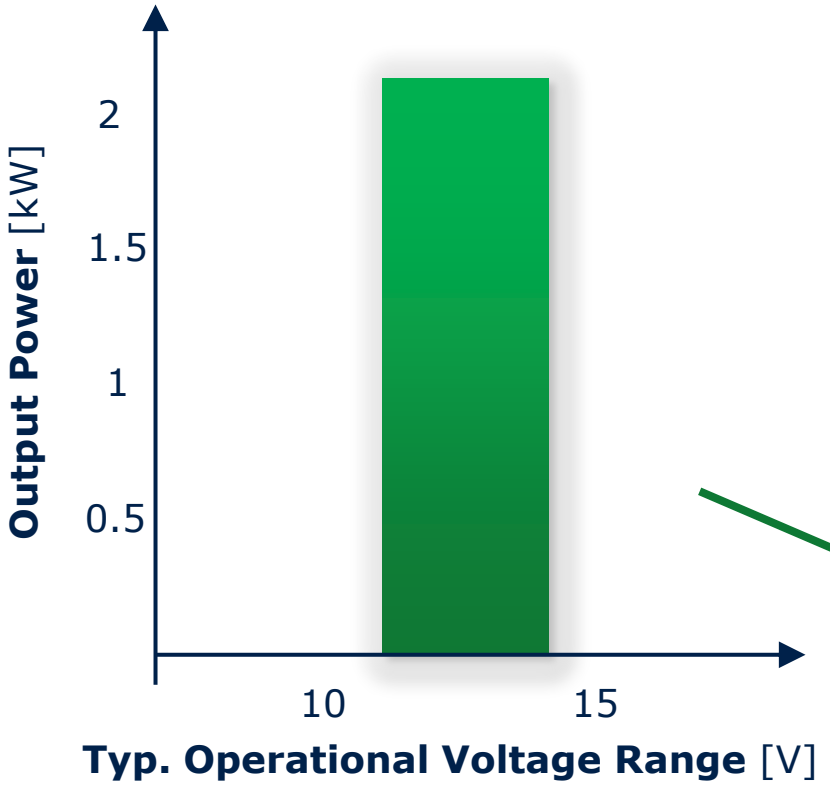
eMobility Requires a New Dimension of Power Semiconductor Performance

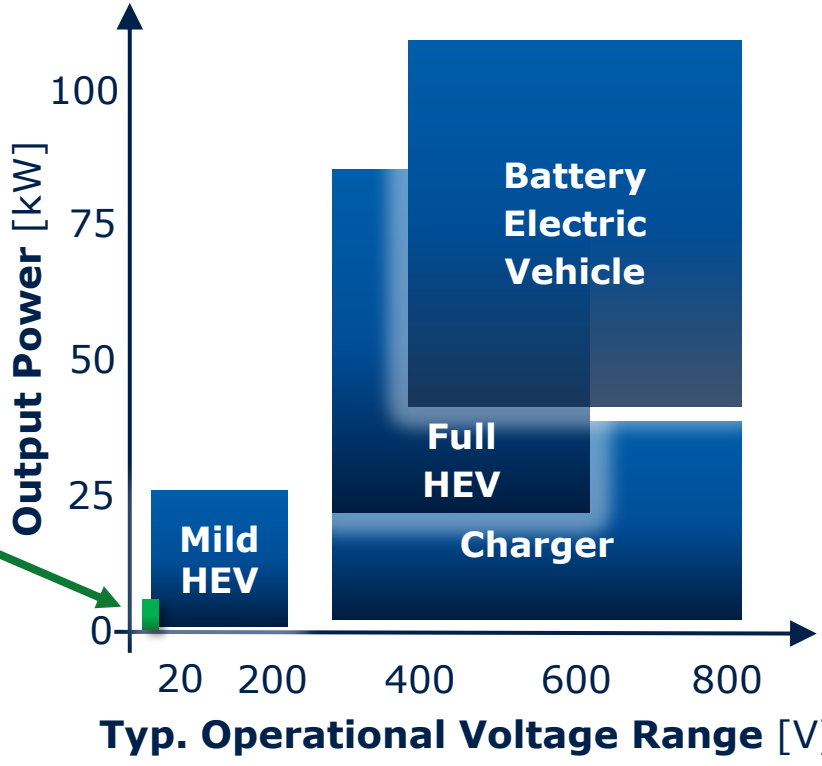
Power demand for ICE





Power demand for eMobility





ICE = internal combustion engine.

HEV = hybrid electric vehicle.

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IMM Split Into Two New Divisions as of 1 January 2012

Industrial & Multimarket (IMM)

Industrial Power Control (IPC)

Applications

- Industry-oriented applications
- Drives and traction
- Home appliances
- Renewable energies (wind, solar)






Products

- IGBT modules
- Module solutions (stacks)
- Discrete IGBTs
- Driver ICs

Power Management & Multimarket (PMM)

Applications

- Power conversion and RF applications
- Power supplies computer and server
- Lighting
- Cellular infrastructure






Products

- Power MOSFETs, Power ICs, DPM*
- RF power devices
- LED drivers
- Small signal components
- ASICs

* DPM = digital power management

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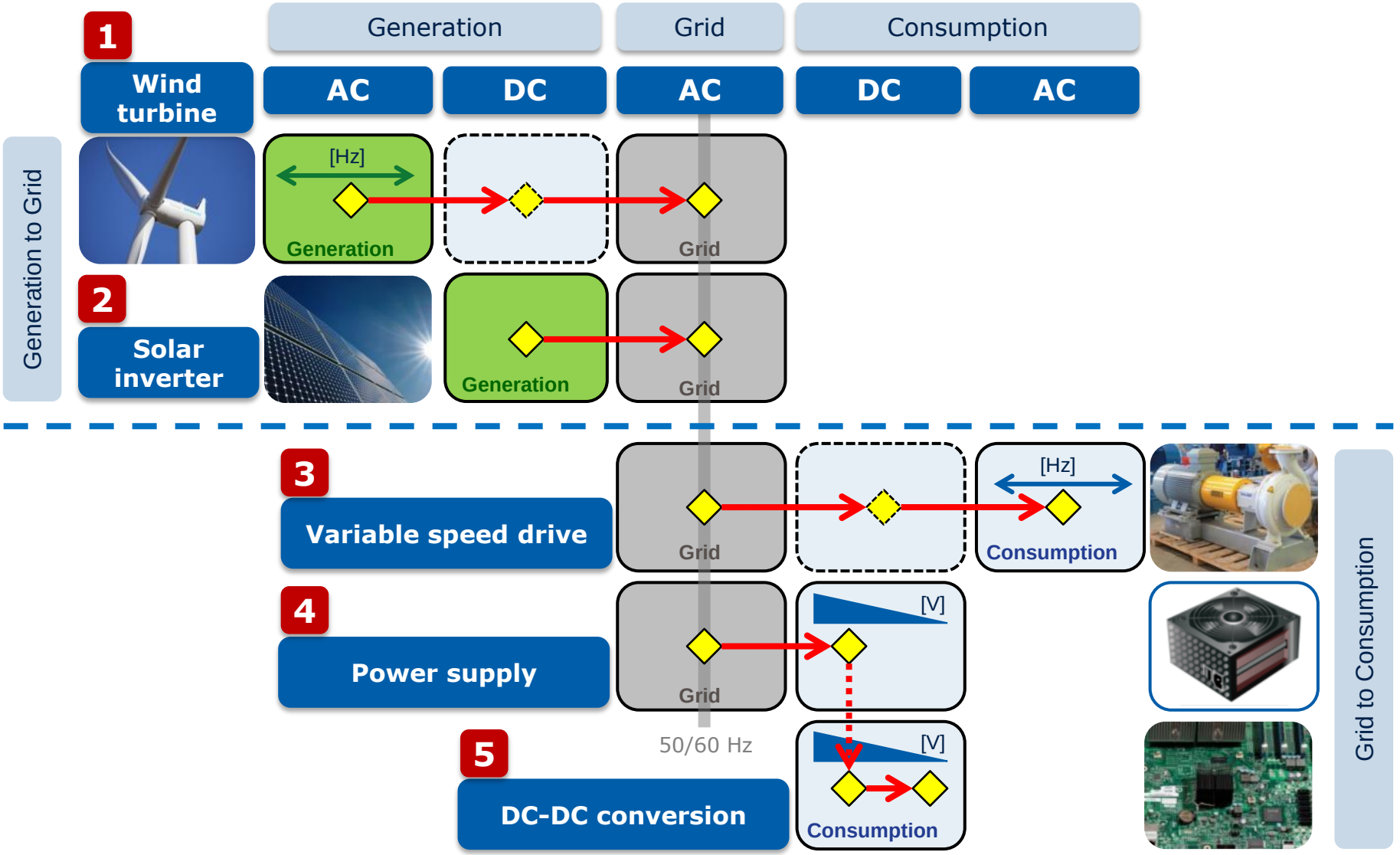
Every Electricity Conversion Step Requires Infineon Components



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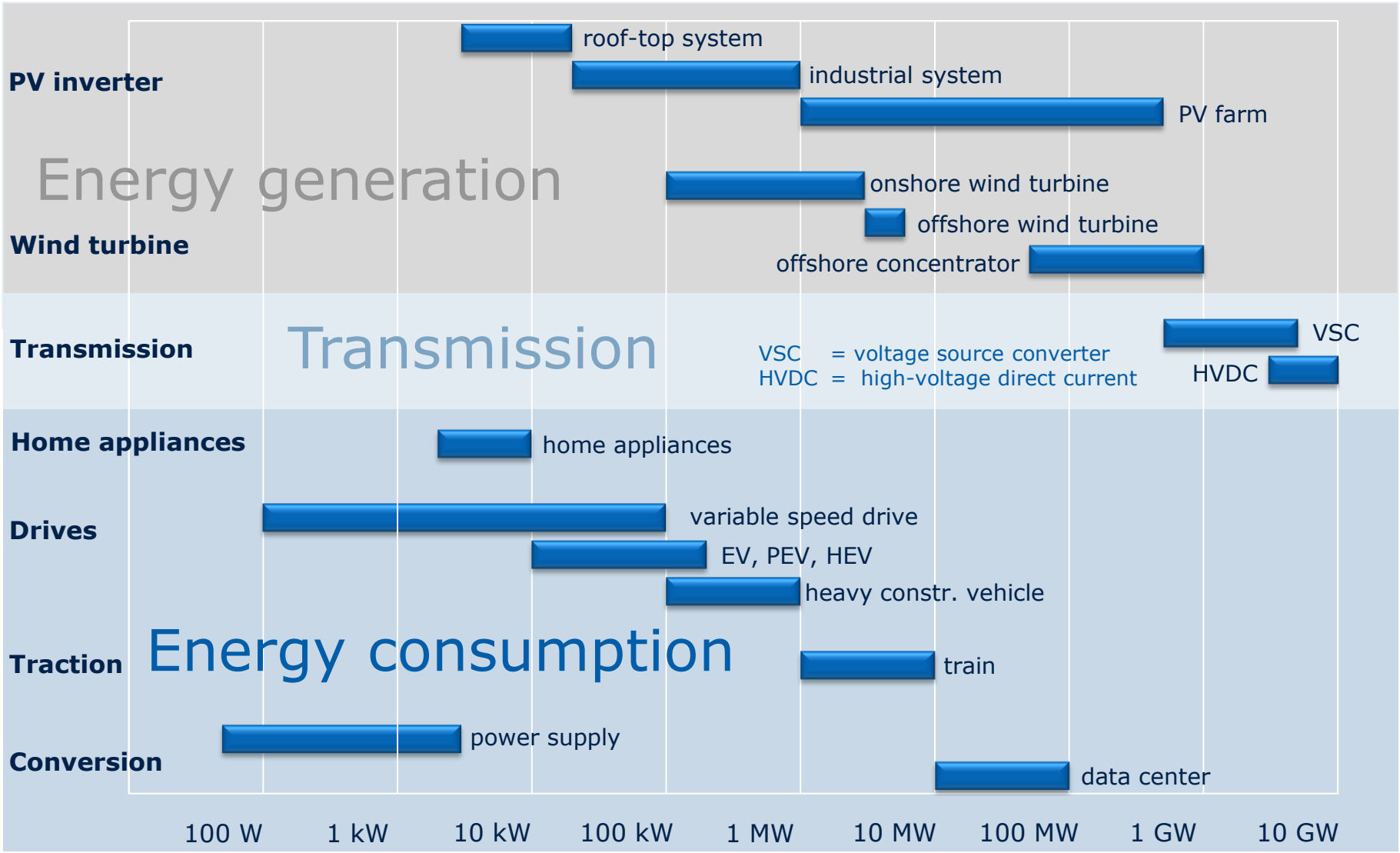
Power in Watt by Application (Examples)



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About 10% Growth p.a. for Cycle Average Expected for Infineon

ATV	IPC + PMM	CCS
	 	
ATV growth: **~10% p.a.**	**IPC + PMM growth:** **> 10% p.a.**	**CCS growth:** **~5-7% p.a.**

Growth target

Infineon: ~10% growth p.a. cycle average

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Target to Sustain 15% Cycle-Average Segment Result Margin

#1	#2	#3	#4
High barriers to entry	Semiconductors enable high functionality	Value of semis small relative to end product	Infineon's core competencies: Power and eControl

ATV	IPC	PMM	CCS









Total profitability target

Infineon: ~15% operating margin cycle-average

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Guidance for Q3 and FY 2012

	Outlook Q3 FY12* (compared to Q2 FY12)	Outlook FY 2012* (compared to FY 2011)
Revenue	Revenue to be broadly flat quarter-on-quarter.	Low single-digit percentage decline. previously: Mid single-digit percentage decline.
Segment Result Margin	Broadly flat.	Mid-teens percentage. previously: Low-to-mid teens percentage.

* This outlook is based on an assumed US-dollar-to-Euro exchange rate for the remainder of the year in line with the average of the first half of the year.

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Environmental Sustainability
Our CO_2 Balance

IFX is a key enabler of sustainable society

Environmental benefits

CO_2 savings enabled through our products[1]:

4,735,000 tons CO_2



Environmental burden

CO_2 burden of our total operations[2] equivalent to

1,100,000 tons CO_2

IFX enables a net ecological benefit of more than

3.6 million tons of CO_2 emission reduction per year!

1) Considering only Automotive products, ballast control, PC power supply, IFX controllers; real figure is higher.
2) Including manufacturing, transport, travel, material, chemistry, emissions, water, waste water values are based on internal figures as well as official data as of June 2012.

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Infineon Has a Long Track Record in Responsibility and Sustainability

UN Global Compact Initiative

- As one of the first semiconductor companies worldwide, Infineon joined the Global Compact Initiative of the United Nations in 2004.

Dow Jones Sustainability Index

Dow Jones Sustainability Indexes
Member 2011/12

- Infineon is currently Europe's one and only semiconductor company member in the Dow Jones Sustainability Indexes.

Certifications



DET NORSKE VERITAS
MANAGEMENT SYSTEM CERTIFICATE

Certificate No.: 46456-2009-HSO-GER-DNV

This is to certify that

Infineon Technologies AG
Am Campeon 1-12
85579 Neubiberg, Germany

as well as the sites and remote locations listed on the following page
have been found to conform to the
Environmental as well as Occupational Health and Safety Management System Standards
ISO 14001:2004
and
OHSAS 18001:2007

This certificate is valid for the following product or service ranges:

Development, production and sales
of semiconductor components

This certificate is valid until: 31.01.2012

Place and date: Essen, 01.02.2009

- Based on our efforts for resources management, safety and health standards, Infineon received the EN ISO 14001 and OHSAS 18001 multi-site certification.

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ENERGY EFFICIENCY
MOBILITY
SECURITY

Innovative semiconductor solutions for energy efficiency, mobility and security.





Infineon's Outstanding ESG Achievements

- Despite stricter reporting requirements, our accident rate remains as industry benchmark compared with the figures issued by the German Social Accident Insurance Institution for the energy, textile, electrical and media products sectors.
- Voluntary and comprehensive due dilligence within our supply chain on the non-use of conflict minerals.
- Best in class in water and energy efficient consumption in manufacturing according to the benchmark of the World Semiconductor Council (WSC).
- Best in class in sustainable resources use in manufacturing according to the benchmark of the World Semiconductor Council (WSC).
- Fullfillment of the voluntary target on PFC (Kyoto gases) reduction in Germany, Europe and worldwide.
- For the second time among the 15% most sustainable companies in the world according to the Sustainability Yearbook.
- Our products are subject to an unique life-cycle analysis approach for the optimization of their environmental footprint.
- Leader of the industry "DA5 Consortium" to find out a Pb-free solder die-attach technology development for automotive applications.

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Superior Growth and Profitability Allow Sustained Investments Over the Cycle

Superior growth and profitability

- Focus on secular growth drivers, e.g. renewables, e-mobility, energy efficiency.
- Leading market share and competitive strengths.
- Financial targets (on average over the cycle):
  - 10% growth p. a. and
  - 15% Segment Result margin.

Sustained investments for future success

- Counter-cyclical investments, selling and R&D to enable further share gains.
- Investments secure capacity for future growth and competitive advantage.
- 300mm power discretes; 200mm, quality, innovation, automation etc.

Strong returns

- Value creation:
  RoCE well in excess of our capital cost with 27% in Q1 FY12 and 25% in Q2 FY12.
- Capital returns through dividend payments, share buyback, and CB 2014 buyback.
- Aggregate capital returns since Q1 FY11 amount to more than EUR 500m.

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4 Reasons for Sustainable Profitability – #1 High Barriers to Entry

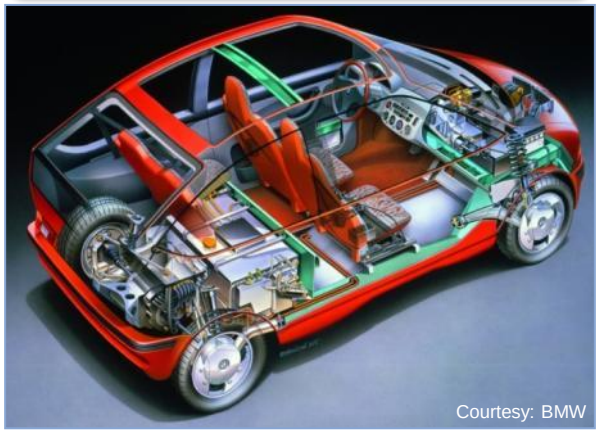
Long product life cycles



Courtesy: Siemens

- For many markets we address, deliveries of semis need to be ensured for very long periods of time:
  - for car industry: 7 to 24 years;
  - for train industry: about 15 years.

System knowhow and understanding


Courtesy: BMW

- Both deep and wide know-how and understanding of our customers' applications needed for making best in class solutions:
  - e.g. HEV/EV needs both automotive and industrial expertise.

Strong quality and reliability req's



- Products need to reliably perform well in the field over longer periods of time:
  - airbag reliability required as long as the car is in use;
  - wind turbines should function 30 years.

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#2 Semiconductors – Core Enablers of Innovation and Higher Functionality

Energy Efficiency



- **Power supplies**
  More advanced power semiconductors allow smaller, denser, lighter and more efficient power supplies.
- **VSD**
  More precise and efficient RPM-control versus mechanical transmission.

Mobility



- **Recuperation**
  Implemented in trains for years; brought to cars by the advent of HEV/EVs.
- **Power steering**
  EPS is replacing hydraulic-mechanical power steering allowing more flexibility in car design and less power consumption.

Security



- **Identification**
  Chip-based passports and national ID cards allow much higher level of security compared with paper-only ID cards.
- **Brand protection**
  Chip-based authentication of accessories, e.g. batteries, cartridges.

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#3 Semis Represent a Negligible Part of the Value of the End Product

Example 1: mid-range car



Courtesy: Volkswagen

€25,000



Semi BoM:

€250

1.0% of product value

Example 2: high-speed train



Courtesy: Siemens

€10,000,000



Semi BoM:

€100,000

1.0% of product value

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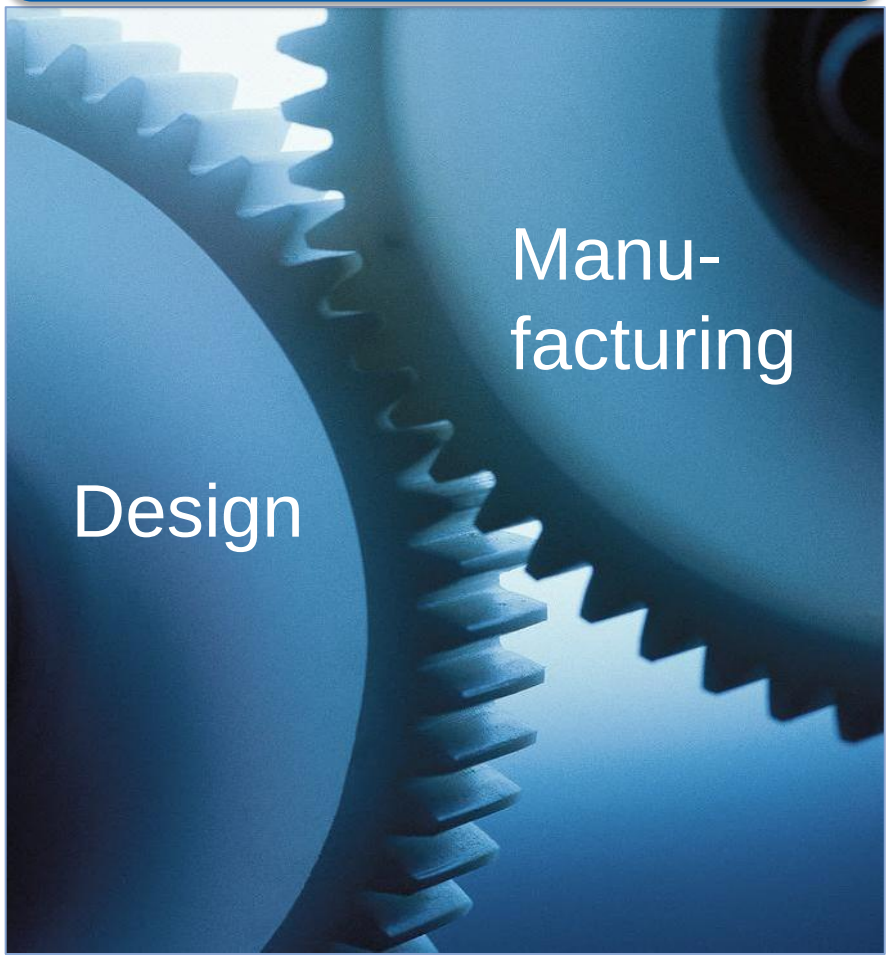
#4 Infineon's Core Competencies — Power Semiconductors and eControl

Design and manufacturing of power semis tightly coupled



Core competence power

- Thin-wafer technology
- Super-junction MOSFETs
- Silicon-Carbide (SiC)
- IGBT module packaging

Core competence eControl

- Automotive real-time 32-bit microcontroller (TriCore™) and multi-core design (AURIX™).
- Industry microcontroller with premium peripheral functions (XMC4000 family).
- Low-power security controller.

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All-Time-High in Revenues in ATV; Strong Recovery in CCS

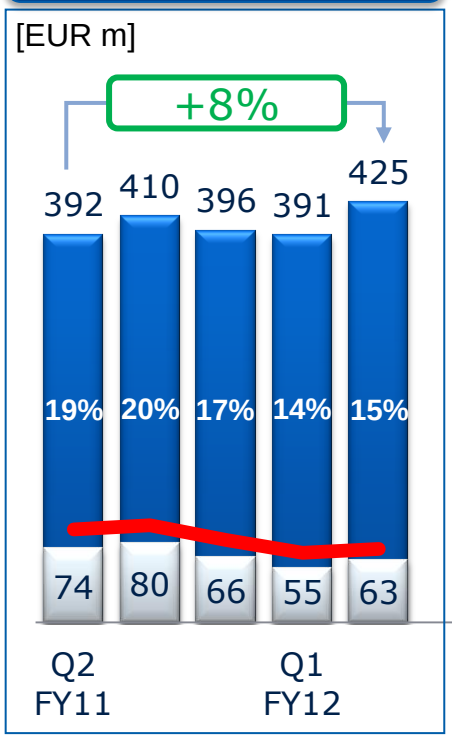




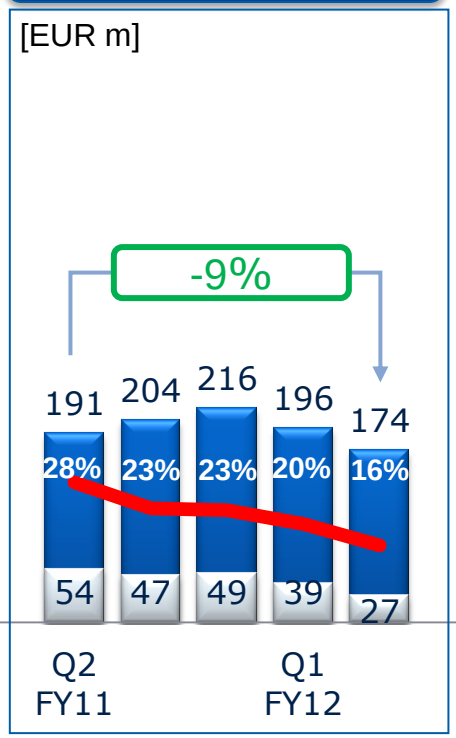




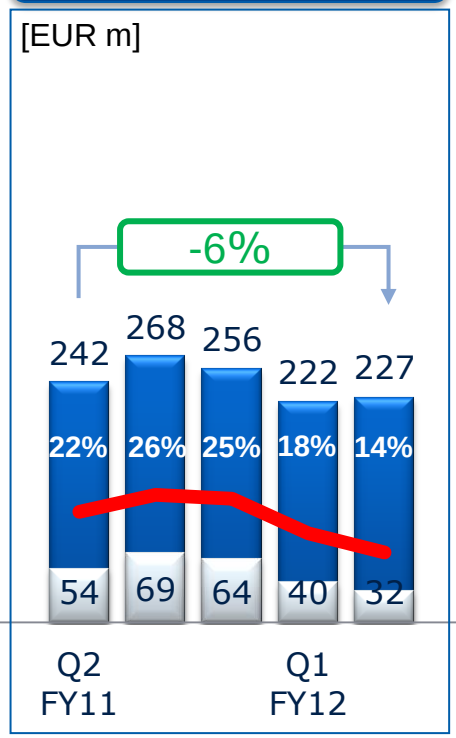
ATV



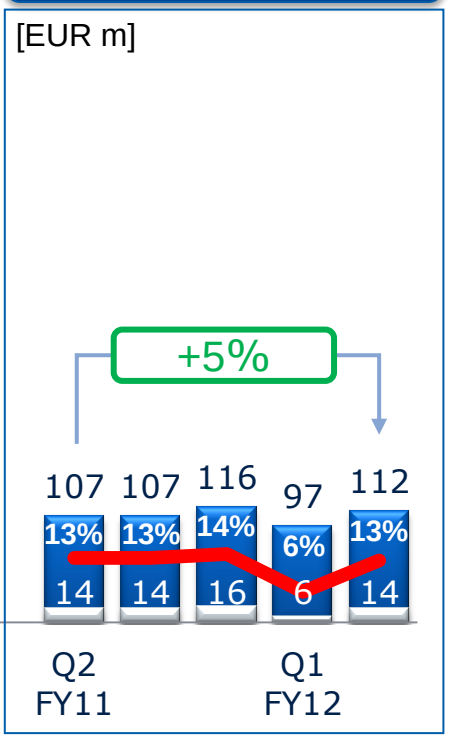
IPC



PMM



CCS



Revenue Segment Result Segment Result margin

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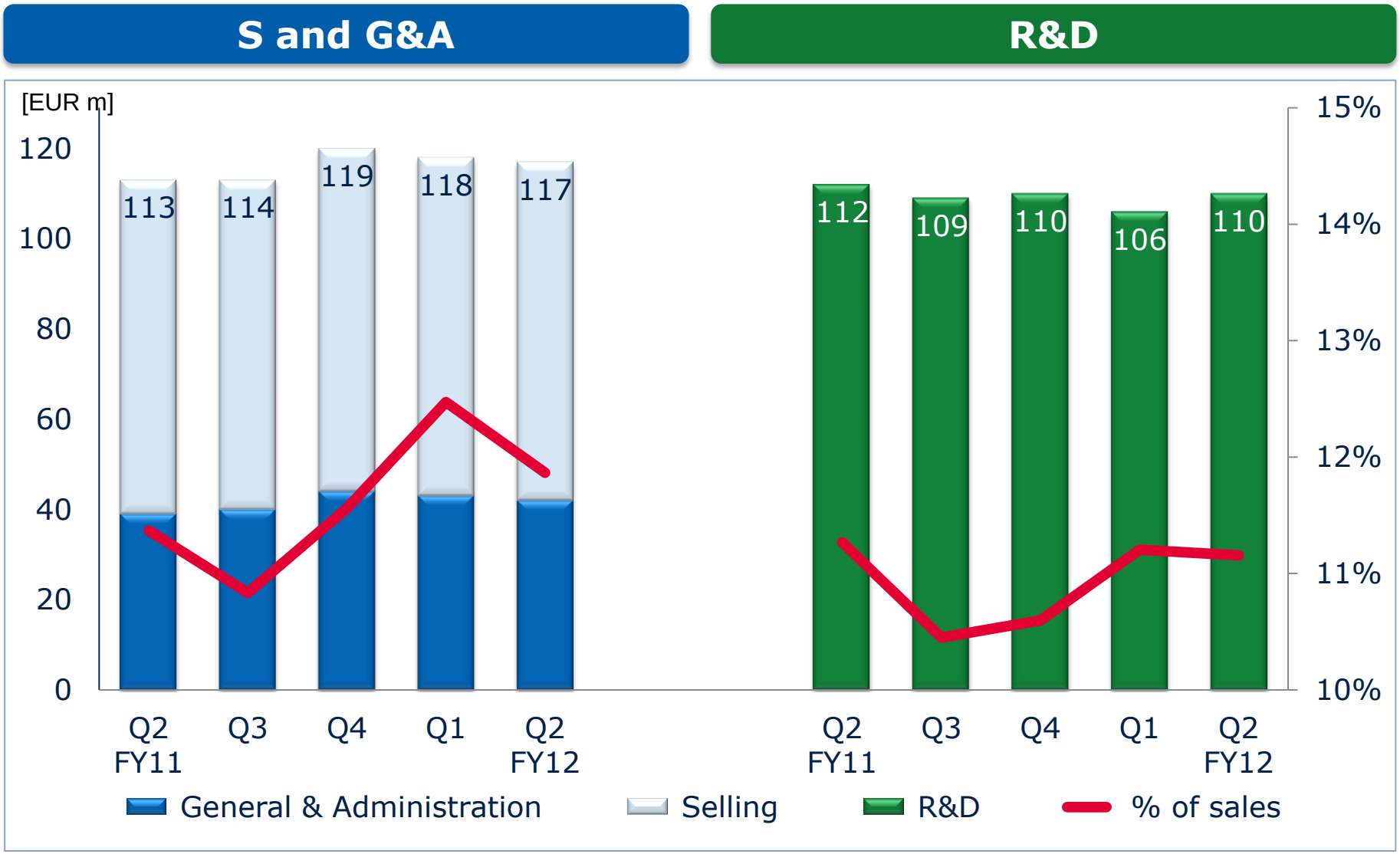
OpEx In-line With Target Operating Model



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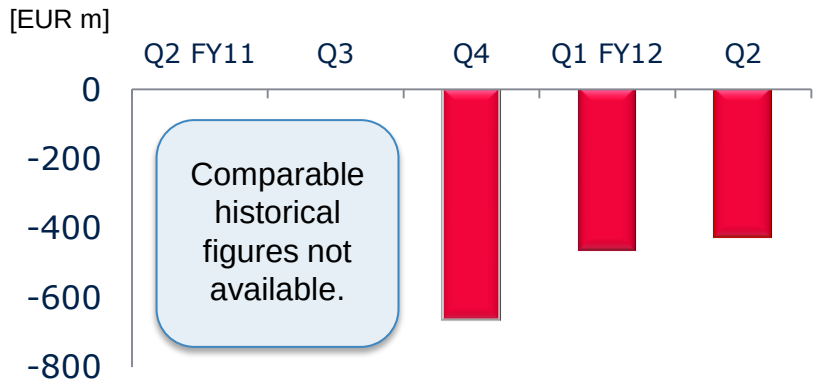
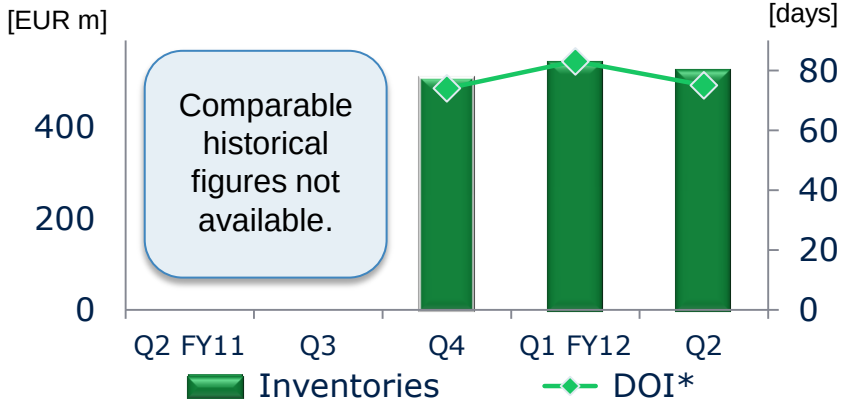
Working Capital

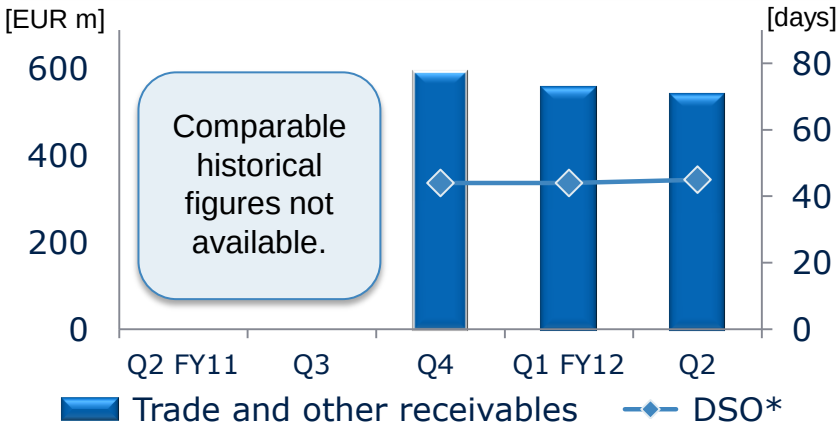
Working capital*



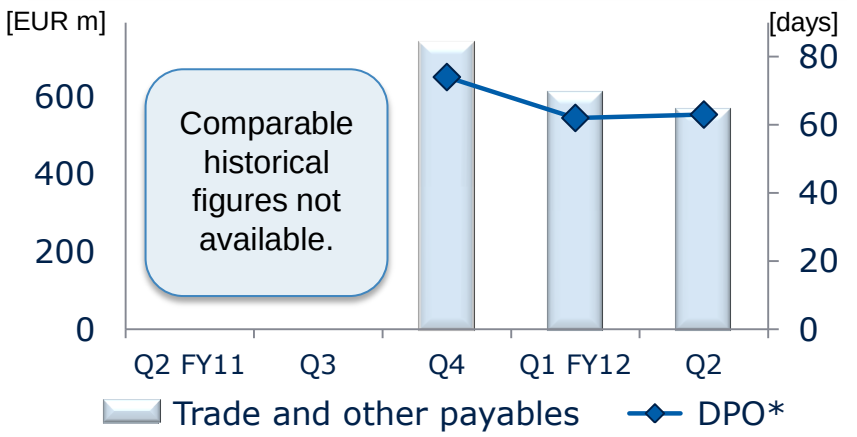
Inventories



Trade and other receivables



Trade and other payables



* For definition please see page 42.

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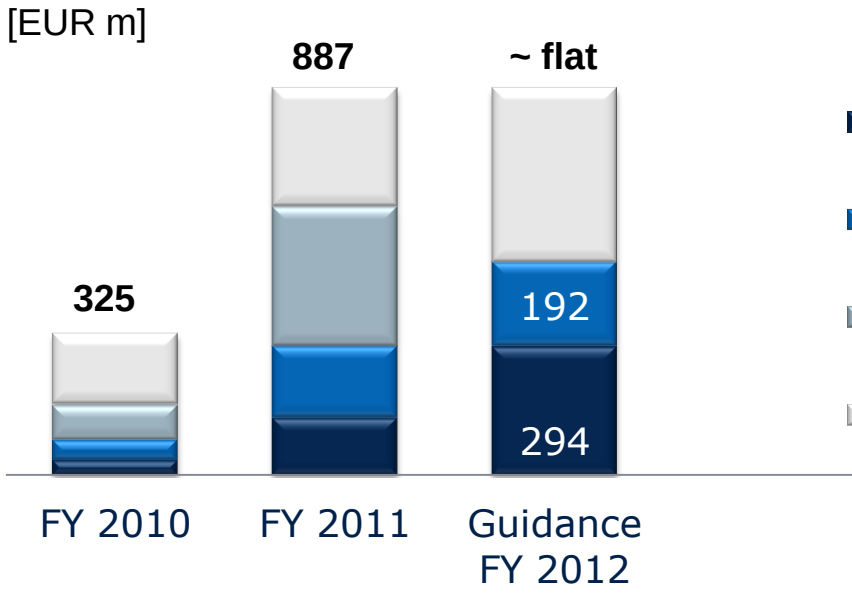
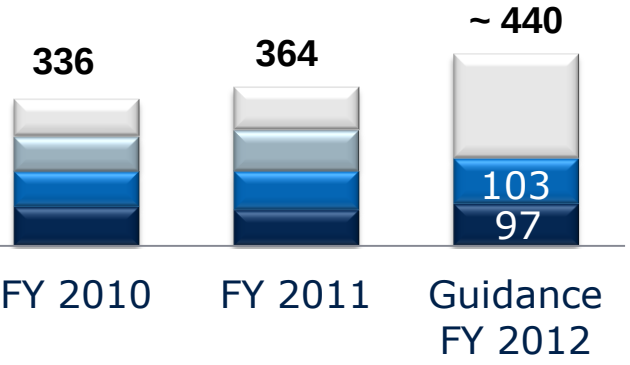
Investments Remain High to Exploit Growth Potential

Investments*



D&A



Guidance for investments:

- FY13: below investments in FY12
- beyond FY13: 10 – 15% of sales

Guidance for D&A:

- FY13: increase compared to FY12
- beyond FY13: 10 – 15% of sales

* For definition please see page 42.

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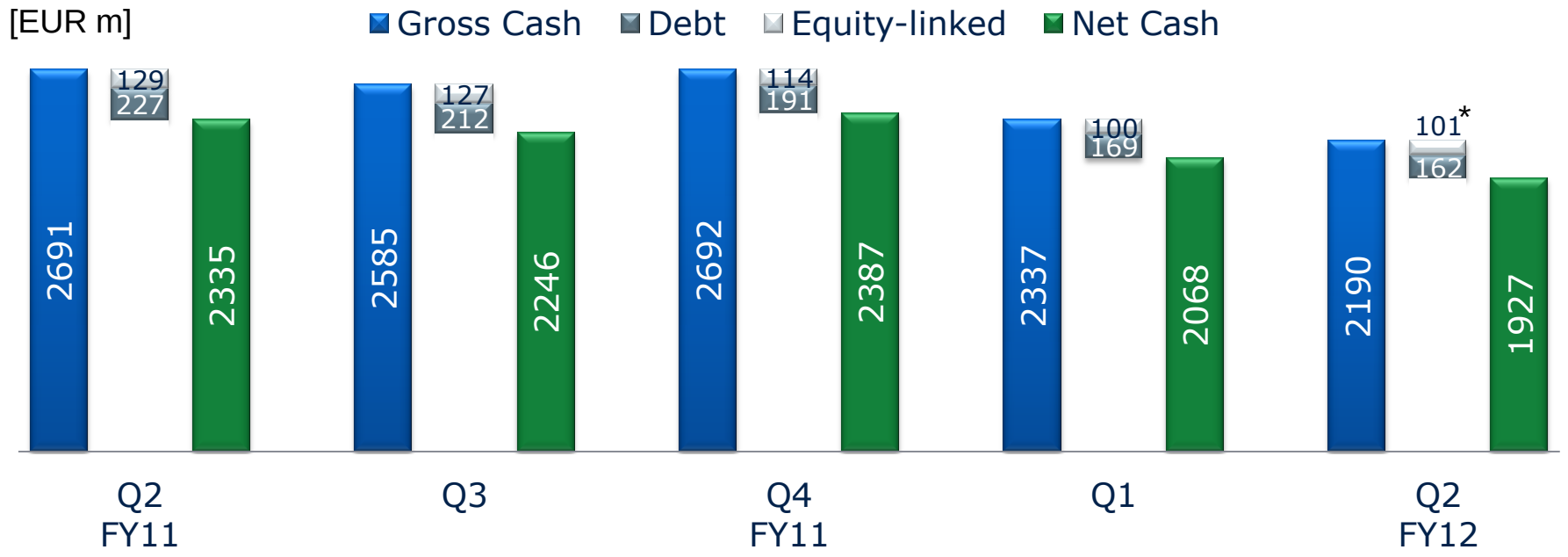
High Gross and Net Cash Position Maintained

Liquidity Development



* Consists of convertible bond (nominal value EUR 118m; book value EUR 101m).

- Gross cash decreased due to dividend payments of EUR 130m, negative Free Cash Flow and debt reduction of EUR 7m. Net cash impact therefore lower.
- No buyback of convertible bond or shares during the quarter.
  But put options over 9m shares lapsed with EUR 2.7m premium received.

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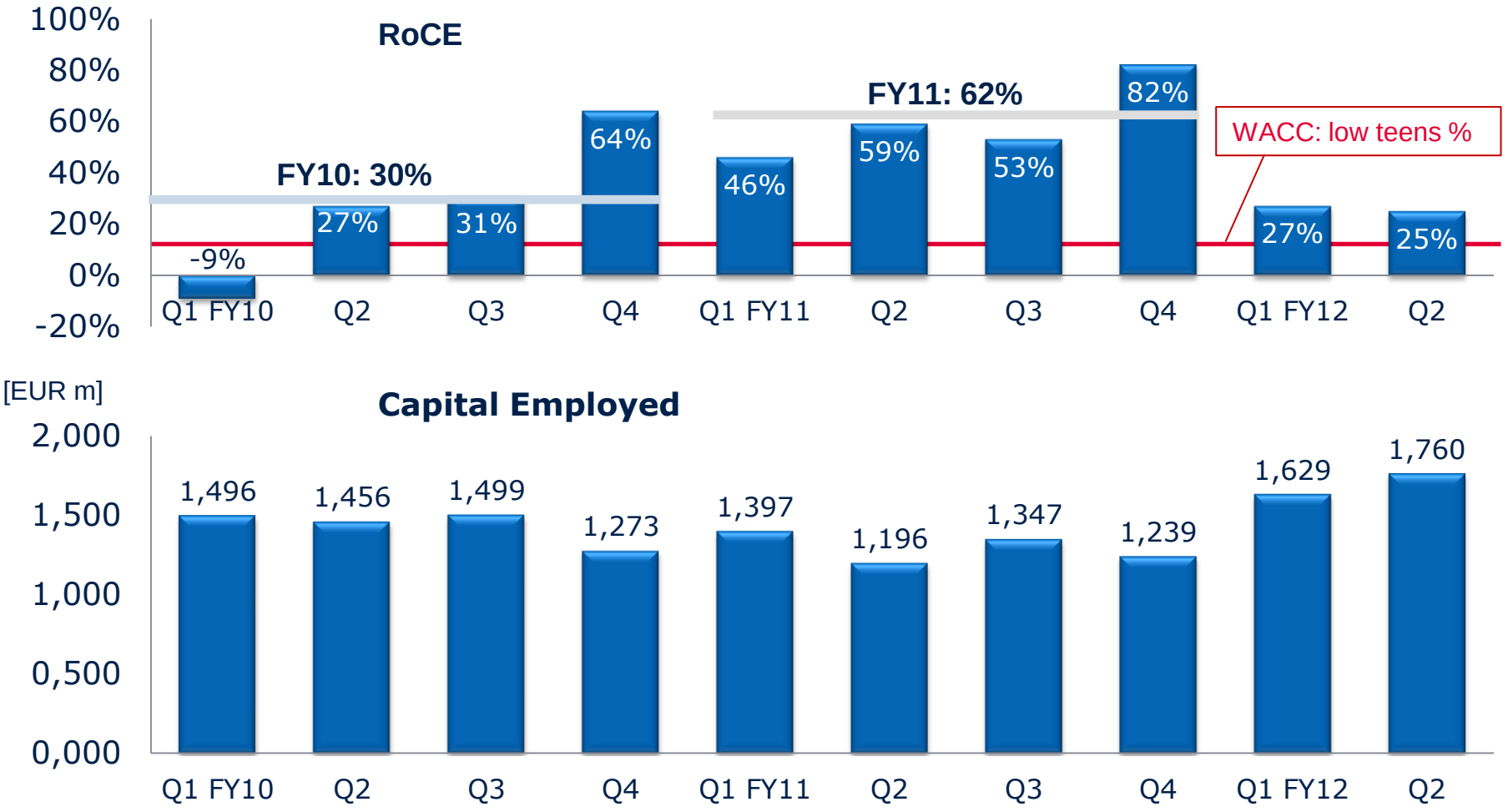
Value Creation of Infineon by Sustainably High RoCE Above WACC

RoCE history and capex



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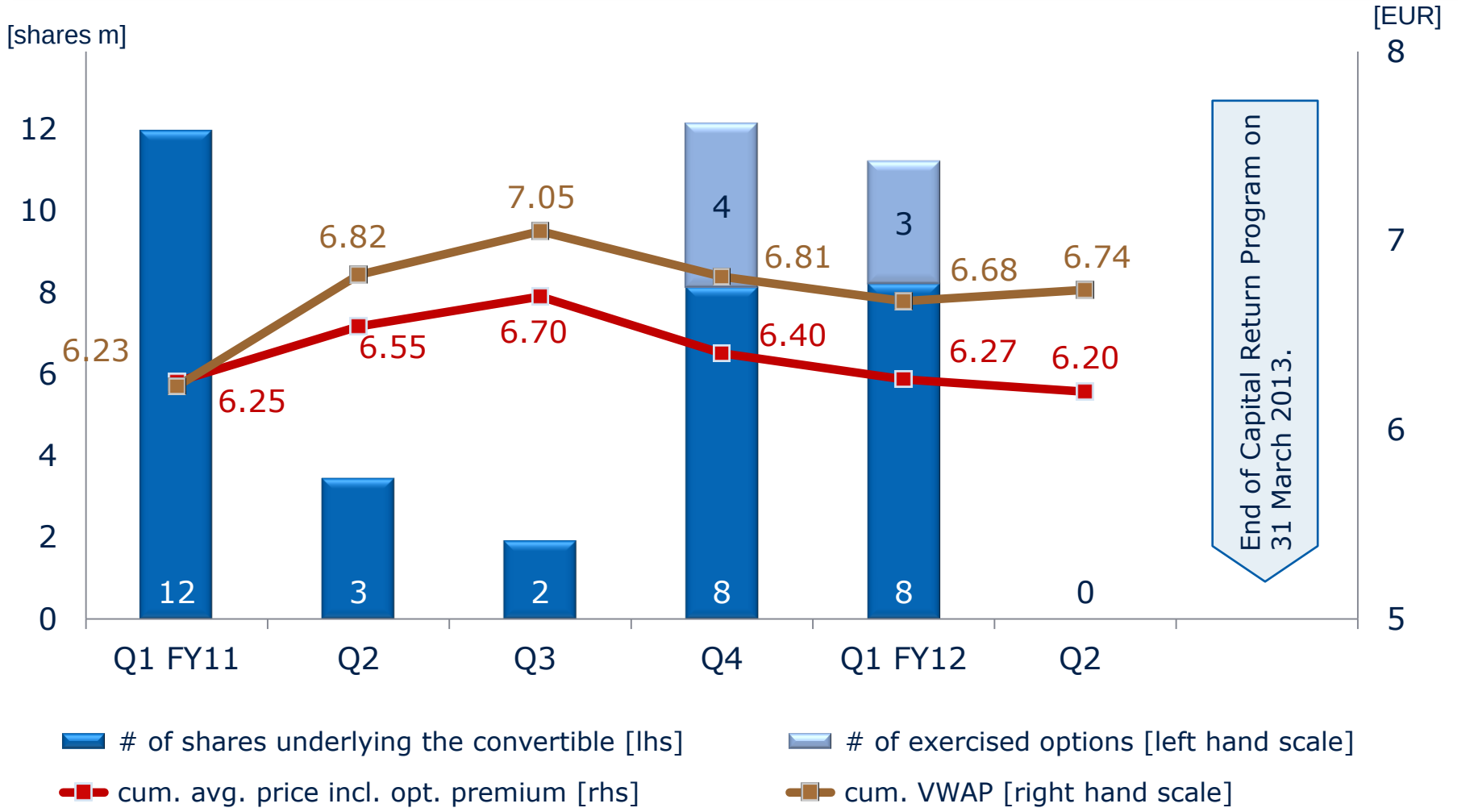
Average Price Per Underlying Share Below Volume Weighted Average Share Price

Total share buyback history via convertible bond and put options



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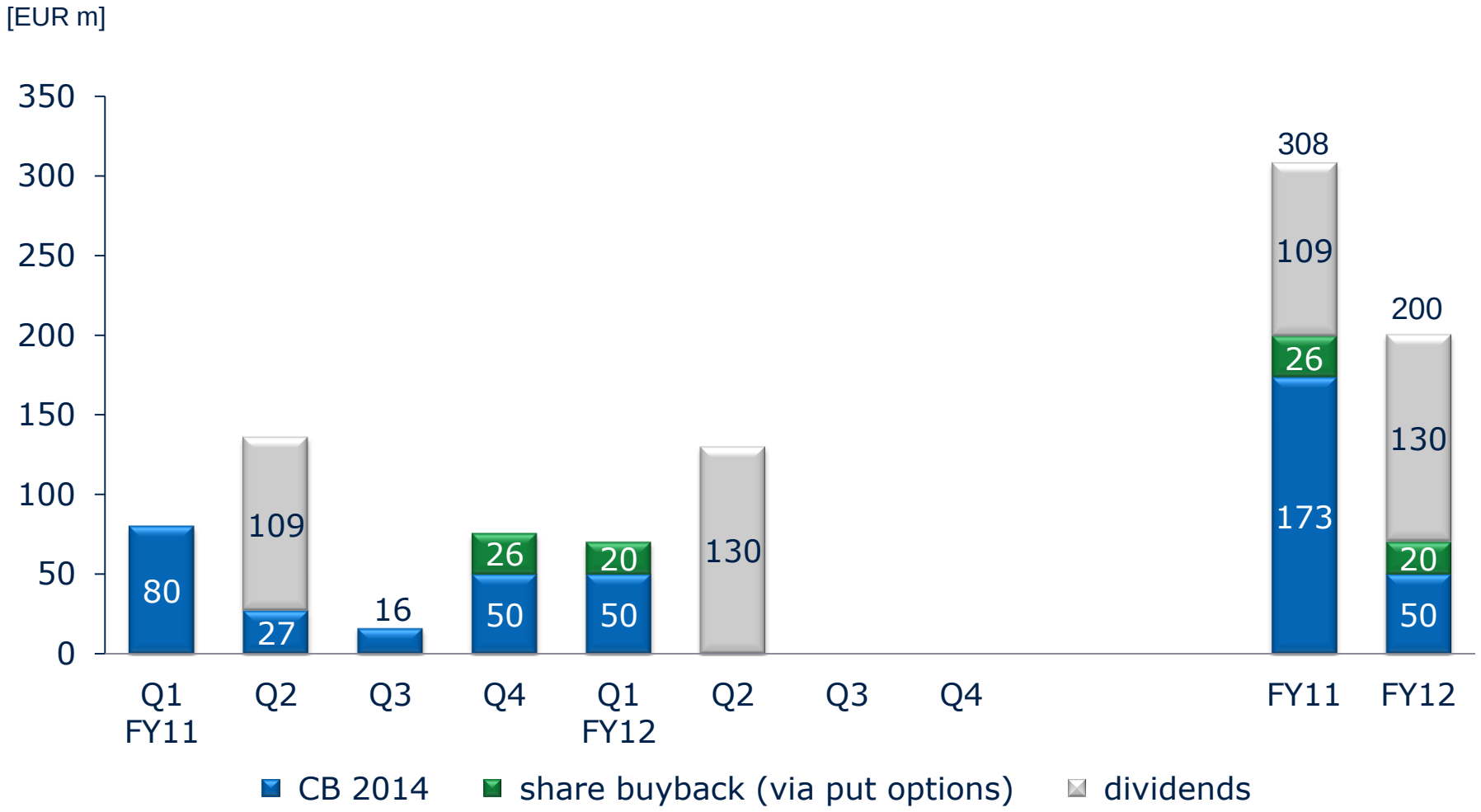
Total Gross Capital Returns

Total gross capital returns history



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Notes

Investments =
'Purchase of property, plant and equipment‘
+ 'Purchase of intangible assets and other assets' *incl. capitalization of R&D expenses*

Working Capital =
('Total current assets‘
– 'Cash and cash equivalents‘
– ‘Financial investment‘
– 'Assets classified as held for sale')
– ('Total current liabilities‘
– 'Short term debt and current maturities of long-term debt‘
– 'Liabilities classified as held for sale')

DOI (inventory days; quarter-to-date) =
('Net Inventories' / 'Cost of goods sold') * 90

DSO (days sales outstanding; quarter-to-date) =
('Trade accounts receivables (net)' / 'revenue') * 90

DPO (days payables outstanding; quarter-to-date) =
('Trade payables' / ['Cost of goods sold' + 'Purchase of property, plant and equipment']) * 90

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Financial Calendar

Date	Location	Event
31 Jul 2012*		Q3 FY12 Results
29-30 Aug 2012	Frankfurt	Commerzbank Sector Conference Week
26 Sep 2012	Munich	Baader Investment Conference
14 Nov 2012*		Q4 FY12 Results
15-16 Nov 2012	Barcelona	Morgan Stanley TMT Conference
27-28 Nov 2012	Scottsdale	Credit Suisse Technology Conference

* preliminary date

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